



Docket No.: M4065.0319/P319-A
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Letters Patent of:
Husam N. Al-Shareef et al.

Patent No.: 7,176,079

Issued: February 13, 2007

For: METHOD OF FABRICATING A
SEMICONDUCTOR DEVICE WITH A WET
OXIDATION WITH STEAM PROCESS

Certificate
MAR 02 2007
of Correction

REQUEST FOR CERTIFICATE OF CORRECTION
PURSUANT TO 37 C.F.R. § 1.322

Attention: Certificate of Correction Branch
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Upon reviewing the above-identified patent, Patentees noted an error which should be corrected.

In Claim 1, the following error is to be corrected:

Column 7, line 3, "thermal chamber" should read --thermal process chamber--.

The error was not in the application as filed by Applicants; accordingly no fee is required.

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DSMDB-2219739v01

Patent No.: 7,176,079

Docket No.: M4065.0319/P319-A

Transmitted herewith is a proposed Certificate of Correction effecting such amendment. Patentees respectfully solicit the granting of the requested Certificate of Correction.

Dated: February 28, 2007

Respectfully submitted,

By 

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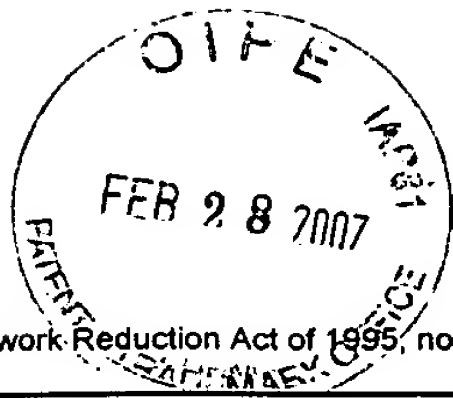
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U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE
(Also Form PTO-1050)

UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

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PATENT NO. : 7,176,079
APPLICATION NO. : 09/912,558
ISSUE DATE : February 13, 2007
INVENTORS : Husam N. Al-Shareef et al.

It is certified that an error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

In Claim 1, the following error is corrected:

Column 7, line 3, "thermal chamber" should read --thermal process chamber--.

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